PRODUCT / PROCESS CHANGE NOTIFICATION

| 1. PCN basic data | | |
|----------------------|----------------|---|
| 1.1 Company | life.augmented | STMicroelectronics International N.V |
| 1.2 PCN No. | | ADG/23/14311 |
| 1.3 Title of PCN | | MOSFETs housed in TO-220: Discontinuation of ST Back End Production Line and Transfer to TFME (Assy and Final Test) |
| 1.4 Product Category | | see list |
| 1.5 Issue date | | 2023-10-03 |

| 2. PCN Team | |
|---------------------------|---------------------------------|
| 2.1 Contact supplier | |
| 2.1.1 Name | KRAUSE INA |
| 2.1.2 Phone | +49 89460062370 |
| 2.1.3 Email | ina.krause@st.com |
| 2.2 Change responsibility | |
| 2.2.1 Product Manager | Mario ASTUTI |
| 2.1.2 Marketing Manager | Anna RANIOLO, Martina GIUFFRIDA |
| 2.1.3 Quality Manager | Diego Maria FERRARI |

| 3. Change | | |
|--------------|---|----------------------------|
| 3.1 Category | 3.2 Type of change | 3.3 Manufacturing Location |
| | Line transfer for a full process or process brick (process step, control plan, recipes) from one site to another site: Assembly site (SOP 2617) | |

| 4. Description of change | | |
|---|--|---|
| | Old | New |
| 4.1 Description | Assembly and Final Test in ST Shenzhen - China | Assembly and Final Test in TFME Nantong Fujitsu - China |
| 4.2 Anticipated Impact on form,fit, function, quality, reliability or processability? | No Impact | |

| 5. Reason / motivation for change | |
|-----------------------------------|---|
| 5.1 Motivation | Service Continuity - Discontinuation of Back-End production line at ST SHENZHEN plant |
| 5.2 Customer Benefit | SERVICE CONTINUITY |

| | 6. Marking of parts / traceability of change |
|-----------------|--|
| 6.1 Description | Dedicated Finished Good Codes |

| 7. Timing / schedule | |
|-------------------------------------|--------------|
| 7.1 Date of qualification results | 2023-09-22 |
| 7.2 Intended start of delivery | 2024-01-01 |
| 7.3 Qualification sample available? | Upon Request |

| 8. Qualification / Validation | | | |
|--|---|---------------|------------|
| 8.1 Description | 14311 Validaton report RERLVIP23039_1.0.pdf | | |
| 8.2 Qualification report and qualification results | Available (see attachment) | Issue Date | 2023-10-03 |

9. Attachments (additional documentations)

14311 Public product.pdf 14311 Details.pdf 14311 Validaton report RERLVIP23039_1.0.pdf

| 10. Affected parts | | | |
|-------------------------|-------------------------|--------------------------|--|
| 10. 1 Current | | 10.2 New (if applicable) | |
| 10.1.1 Customer Part No | 10.1.2 Supplier Part No | 10.1.2 Supplier Part No | |
| | STF100N10F7 | | |
| | STF19NF20 | | |

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